

(12) INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT)

(19) World Intellectual Property Organization International Bureau



(43) International Publication Date
20 January 2005 (20.01.2005)

PCT

(10) International Publication Number
WO 2005/006361 A3

(51) International Patent Classification⁷: **H01L 23/373**

(21) International Application Number:
PCT/US2004/018164

(22) International Filing Date: 3 June 2004 (03.06.2004)

(25) Filing Language: English

(26) Publication Language: English

(30) Priority Data:
10/607,738 26 June 2003 (26.06.2003) US

(71) Applicant: INTEL CORPORATION [US/US]; 2200 Mission College Boulevard, Santa Clara, CA 95052 (US).

(72) Inventors: HOULE, Sabina; 1347 East Redwood Lane, Phoenix, AZ 85048 (US). DANI, Ashay; 602 West Canary Way, Chyandler, AZ 85248 (US).

(74) Agents: STEFFEY, Charles, E. et al.; Schwegman, Lundberg, Woessner & Kluth P.A., P.O. Box 2938, Minneapolis, MN 55402 (US).

(81) Designated States (unless otherwise indicated, for every kind of national protection available): AE, AG, AL, AM, AT, AU, AZ, BA, BB, BG, BR, BW, BY, BZ, CA, CH, CN,

CO, CR, CU, CZ, DE, DK, DM, DZ, EC, EE, EG, ES, FI, GB, GD, GE, GH, GM, HR, HU, ID, IL, IN, IS, JP, KE, KG, KP, KR, KZ, LC, LK, LR, LS, LT, LU, LV, MA, MD, MG, MK, MN, MW, MX, MZ, NA, NI, NO, NZ, OM, PG, PH, PL, PT, RO, RU, SC, SD, SE, SG, SK, SL, SY, TJ, TM, TN, TR, TT, TZ, UA, UG, US, UZ, VC, VN, YU, ZA, ZM, ZW.

(84) Designated States (unless otherwise indicated, for every kind of regional protection available): ARIPO (BW, GH, GM, KE, LS, MW, MZ, NA, SD, SL, SZ, TZ, UG, ZM, ZW), Eurasian (AM, AZ, BY, KG, KZ, MD, RU, TJ, TM), European (AT, BE, BG, CH, CY, CZ, DE, DK, EE, ES, FI, FR, GB, GR, HU, IE, IT, LU, MC, NL, PL, PT, RO, SE, SI, SK, TR), OAPI (BF, BJ, CF, CG, CI, CM, GA, GN, GQ, GW, ML, MR, NE, SN, TD, TG).

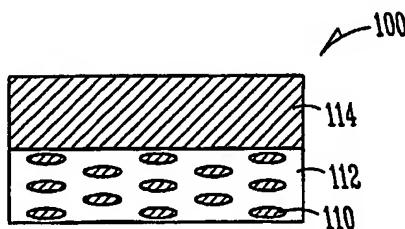
Published:

- with international search report
- before the expiration of the time limit for amending the claims and to be republished in the event of receipt of amendments

(88) Date of publication of the international search report:
28 July 2005

For two-letter codes and other abbreviations, refer to the "Guidance Notes on Codes and Abbreviations" appearing at the beginning of each regular issue of the PCT Gazette.

(54) Title: MULTI-LAYER POLYMER-SOLDER HYBRID THERMAL INTERFACE MATERIAL FOR INTEGRATED HEAT SPREADER AND METHOD OF MAKING SAME



WO 2005/006361 A3

(57) Abstract: A process of making a multi-layer thermal interface material is depicted. The multi-layer thermal interface material is attached between an integrated heat spreader and a die. Processing of the multi-layer thermal interface material includes stamping or other pressure processing.

INTERNATIONAL SEARCH REPORT

Internal Application No
PCT/US2004/018164

A. CLASSIFICATION OF SUBJECT MATTER
IPC 7 H01L23/373

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)
IPC 7 H01L

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practical, search terms used)

EPO-Internal, WPI Data, PAJ

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category *	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	US 5 981 085 A (NINOMIYA ET AL) 9 November 1999 (1999-11-09) column 4, line 10 - column 9, line 42; figures 2,8 ----- US 4 782 893 A (THOMAS ET AL) 8 November 1988 (1988-11-08) *see Figure 2 and accompanying description* ----- US 2002/135984 A1 (GREENWOOD ALFRED W ET AL) 26 September 2002 (2002-09-26) paragraphs [0036] - [0045], [0051], [0056]; figures 1,4 ----- -/-	1,2,5,6, 16,19-21 1,2, 5-10,16, 18-24 1,2, 5-10,16, 18-24 -/-
Y		
Y		

Further documents are listed in the continuation of box C.

Patent family members are listed in annex.

* Special categories of cited documents :

- "A" document defining the general state of the art which is not considered to be of particular relevance
- "E" earlier document but published on or after the international filing date
- "L" document which may throw doubts on priority claim(s) or which is cited to establish the publication date of another citation or other special reason (as specified)
- "O" document referring to an oral disclosure, use, exhibition or other means
- "P" document published prior to the international filing date but later than the priority date claimed

- "T" later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention
- "X" document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone
- "Y" document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art.
- "&" document member of the same patent family

Date of the actual completion of the international search

15 February 2005

Date of mailing of the international search report

27/05/2005

Name and mailing address of the ISA

European Patent Office, P.B. 5818 Patentlaan 2
NL - 2280 HV Rijswijk
Tel. (+31-70) 340-2040, Tx. 31 651 epo nl.
Fax: (+31-70) 340-3016

Authorized officer

Cousins, D

INTERNATIONAL SEARCH REPORTInternal..... Application No
PCT/US2004/018164

C.(Continuation) DOCUMENTS CONSIDERED TO BE RELEVANT		
Category	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
Y	WO 02/091395 A (HONEYWELL INTERNATIONAL INC; NGUYEN, MY) 14 November 2002 (2002-11-14) the whole document -----	1,2, 5-10,16, 18-24

INTERNATIONAL SEARCH REPORT

International application No.
PCT/US2004/018164

Box II Observations where certain claims were found unsearchable (Continuation of item 2 of first sheet)

This International Search Report has not been established in respect of certain claims under Article 17(2)(a) for the following reasons:

1. Claims Nos.: because they relate to subject matter not required to be searched by this Authority, namely:

2. Claims Nos.: because they relate to parts of the International Application that do not comply with the prescribed requirements to such an extent that no meaningful International Search can be carried out, specifically:

3. Claims Nos.: because they are dependent claims and are not drafted in accordance with the second and third sentences of Rule 6.4(a).

Box III Observations where unity of invention is lacking (Continuation of item 3 of first sheet)

This International Searching Authority found multiple inventions in this international application, as follows:

see additional sheet

1. As all required additional search fees were timely paid by the applicant, this International Search Report covers all searchable claims.

2. As all searchable claims could be searched without effort justifying an additional fee, this Authority did not invite payment of any additional fee.

3. As only some of the required additional search fees were timely paid by the applicant, this International Search Report covers only those claims for which fees were paid, specifically claims Nos.:

4. No required additional search fees were timely paid by the applicant. Consequently, this International Search Report is restricted to the invention first mentioned in the claims; it is covered by claims Nos.:

1,2,5-10,16,18-24

Remark on Protest

The additional search fees were accompanied by the applicant's protest.

No protest accompanied the payment of additional search fees.

FURTHER INFORMATION CONTINUED FROM PCT/ISA/ 210

This International Searching Authority found multiple (groups of) inventions in this international application, as follows:

1. claims: 1,2,5-10,16,18-24

Claim 1, 2: thermal interface member having a solder preform disposed on a matrix material, insofar as the transition between the solder preform and the matrix is abrupt, the matrix being of a second heat transfer structure, with second heat transfer structures dispersed in the matrix, the second heat transfer structure being a polymer, the first heat transfer structures being of a material alternative to diamond (viz. graphite, inorganic dielectric particles, metal particles). Claims 5 - 10, 16 (insofar as the transition between the solder preform and the matrix is abrupt), 18 - 24.

2. claims: 1,3,4,16

Claim 1, thermal interface member having a solder preform disposed on a matrix material, insofar as the transition between the solder preform and the matrix is a concentration gradient. Claims 3, 4 directed to a thermal interface member having a solder preform disposed on a matrix material, with a middle heat transfer structure therebetween, the latter having a composition that is transitional between that of the matrix and that of the solder preform. Claim 16 (insofar as the transition between the solder preform and the matrix is a concentration gradient).

3. claims: 11-15

Claims 11-15: a process of forming a heat transfer composite comprising the steps of: mixing and casting a matrix comprising a plurality of first heat transfer structures within a second heat transfer structure of a curable material; and bonding the matrix to a solder layer and forming the matrix is by co-extruding and singulating.

4. claim: 17

Claim 17: Bonding a heat transfer subsystem to a die and a heat spreader at a temperature $(T_{tim} - T_{amb})/2$.

INTERNATIONAL SEARCH REPORT

International Application No
PCT/US2004/018164

Patent document cited in search report	Publication date	Patent family member(s)		Publication date
US 5981085	A 09-11-1999	GB	2311414 A ,B	24-09-1997
		GB	2327150 A ,B	13-01-1999
		JP	10150124 A	02-06-1998
US 4782893	A 08-11-1988	NONE		
US 2002135984	A1 26-09-2002	EP	1354353 A1	22-10-2003
		JP	2004518294 T	17-06-2004
		MX	PA03006498 A	15-10-2003
		TW	552690 B	11-09-2003
		WO	02059965 A1	01-08-2002
WO 02091395	A 14-11-2002	US	2001038093 A1	08-11-2001
		CA	2442034 A1	14-11-2002
		CN	1552078 A	01-12-2004
		EP	1386327 A1	04-02-2004
		JP	2004533705 T	04-11-2004
		WO	02091395 A1	14-11-2002
		US	2004185273 A1	23-09-2004